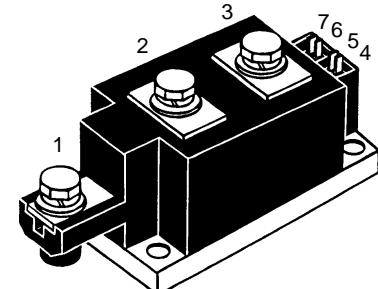


# Thyristor Modules

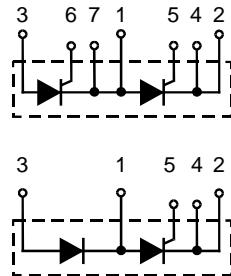
## Thyristor/Diode Modules

**I<sub>TRMS</sub> = 2x 400 A**  
**I<sub>TAVM</sub> = 2x 240 A**  
**V<sub>RRM</sub> = 2000-2200 V**

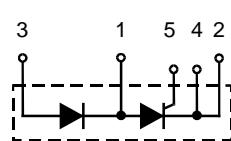
V <sub>RSM</sub>	V <sub>RRM</sub>	Type
V <sub>DSM</sub>	V <sub>DRM</sub>	
V	V	
2100	2000	MCC 224-20io1
2300	2200	MCC 224-22io1
		MCD 224-20io1
		MCD 224-22io1



MCC



MCD



Symbol	Test Conditions		Maximum Ratings	
I <sub>TRMS</sub>	T <sub>VJ</sub> = T <sub>VJM</sub>		400	A
I <sub>TAVM</sub>	T <sub>C</sub> = 85°C; 180° sine		240	A
I <sub>TSM</sub>	T <sub>VJ</sub> = 45°C; V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	8000	A
			8500	A
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	7000	A
			7500	A
j <sup>2</sup> dt	T <sub>VJ</sub> = 45°C V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	320000	A <sup>2</sup> s
			303000	A <sup>2</sup> s
	T <sub>VJ</sub> = T <sub>VJM</sub> V <sub>R</sub> = 0	t = 10 ms (50 Hz) t = 8.3 ms (60 Hz)	245000	A <sup>2</sup> s
			240000	A <sup>2</sup> s
(di/dt) <sub>cr</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> f = 50 Hz, t <sub>p</sub> = 200 µs V <sub>D</sub> = 2/3 V <sub>DRM</sub> I <sub>G</sub> = 1 A di <sub>G</sub> /dt = 1 A/µs	repetitive, non repetitive, I <sub>T</sub> = I <sub>TAVM</sub>	100	A/µs
			500	A/µs
(dv/dt) <sub>cr</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> ; V <sub>DR</sub> = 2/3 V <sub>DRM</sub> R <sub>gk</sub> = ∞; method 1 (linear voltage rise)		1000	V/µs
P <sub>GM</sub>	T <sub>VJ</sub> = T <sub>VJM</sub> I <sub>T</sub> = I <sub>TAVM</sub>	t <sub>p</sub> = 30 µs t <sub>p</sub> = 500 µs	120	W
P <sub>GAV</sub>			60	W
V <sub>RGM</sub>			20	W
T <sub>VJ</sub>			10	V
T <sub>VJM</sub>			-40 ... 130	°C
T <sub>stg</sub>			130	°C
			-40 ... 125	°C
V <sub>ISOL</sub>	50/60 Hz, RMS	t = 1 min	3000	V~
	I <sub>ISOL</sub> ≤ 1 mA	t = 1 s	3600	V~
M <sub>d</sub>	Mounting torque (M6)		4.5-7/40-62	Nm/lb.in.
	Terminal connection torque (M8)		11-13/97-115	Nm/lb.in.
Weight	Typical including screws		750	g

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.  
 IXYS reserves the right to change limits, test conditions and dimensions


**MCC 224  
MCD 224**

Symbol	Test Conditions	Characteristic Values	
$I_{RRM}, I_{DRM}$	$T_{VJ} = T_{VJM}; V_R = V_{RRM}$	40	mA
$V_T$	$I_T = 600 \text{ A}; T_{VJ} = 25^\circ\text{C}$	1.4	V
$V_{TO}$ $r_T$	For power-loss calculations only ( $T_{VJ} = T_{VJM}$ )	0.8	V
		0.76	$\text{m}\Omega$
$V_{GT}$	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	2	V
		3	V
$I_{GT}$	$V_D = 6 \text{ V}; T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	150	mA
		220	mA
$V_{GD}$ $I_{GD}$	$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$ $T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$	0.25	V
		10	mA
$I_L$	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; t_p = 30 \mu\text{s}$ $dI_G/dt = 0.45 \text{ A}/\mu\text{s}; I_G = 0.45 \text{ A}$	200	mA
$I_H$	$T_{VJ} = 25^\circ\text{C}; V_D = 6 \text{ V}; R_{GK} = \infty$	150	mA
$t_{gd}$	$T_{VJ} = 25^\circ\text{C}; V_D = 1/2 V_{DRM}$ $dI_G/dt = 1 \text{ A}/\mu\text{s}; I_G = 1 \text{ A}$	2	$\mu\text{s}$
$t_q$	$T_{VJ} = T_{VJM}; V_R = 100 \text{ V}; V_D = 2/3 V_{DRM}; t_p = 200 \mu\text{s}$ $dv/dt = 50 \text{ V}/\mu\text{s}; I_T = 300 \text{ A}; -di/dt = 10 \text{ A}/\mu\text{s}$	typ. 200	$\mu\text{s}$
$Q_s$ $I_{RM}$	$T_{VJ} = T_{VJM}$ $-di/dt = 50 \text{ A}/\mu\text{s}; I_T = 400 \text{ A}$	760	$\mu\text{C}$
$R_{thJC}$	per thyristor; DC current	0.139	K/W
	per module	0.069	K/W
$R_{thJK}$	per thyristor; DC current	0.179	K/W
	per module	0.089	K/W
$d_s$	Creeping distance on surface	DataSheet4U.co 12.7	mm
$d_A$	Creepage distance in air	9.6	mm
$a$	Maximum allowable acceleration	50	$\text{m}/\text{s}^2$

Optional accessories for modules

Keyed Gate/Cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red

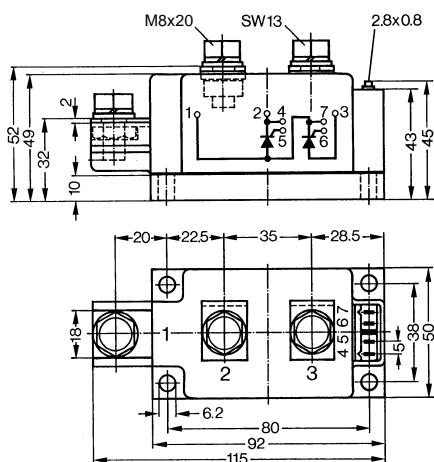
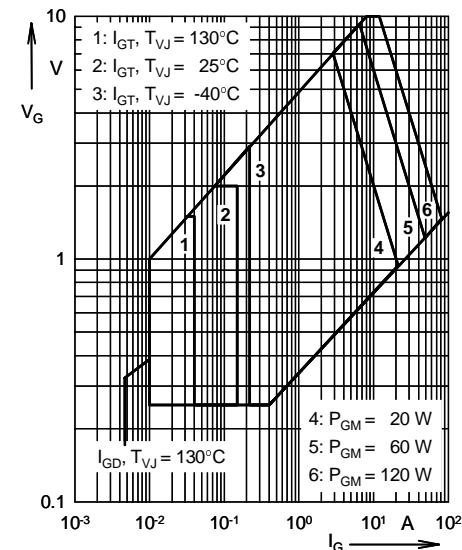
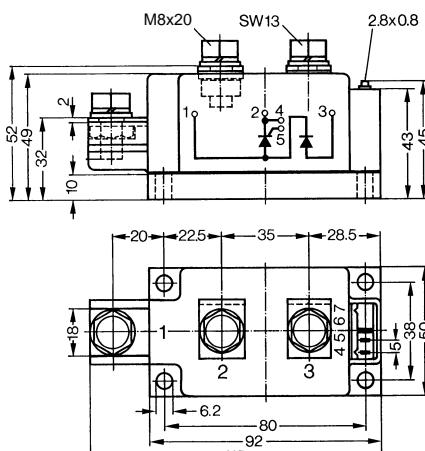
Type **ZY 180 L** (L = Left for pin pair 4/5)      UL 758, style 1385,  
Type **ZY 180 R** (R = Right for pin pair 6/7)      CSA class 5851, guide 460-1-1**Dimensions in mm (1 mm = 0.0394")****MCC****MCD**

Fig. 1 Gate trigger characteristics

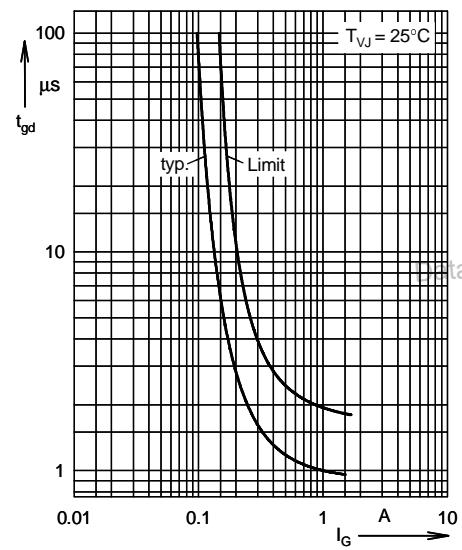


Fig. 2 Gate trigger delay time

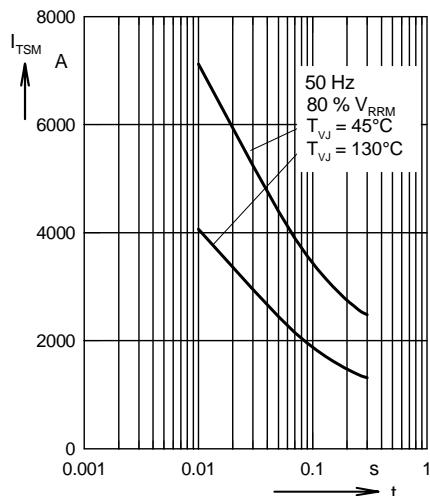


Fig. 3 Surge overload current  
 $I_{TSM}$ : Crest value,  $t$ : duration

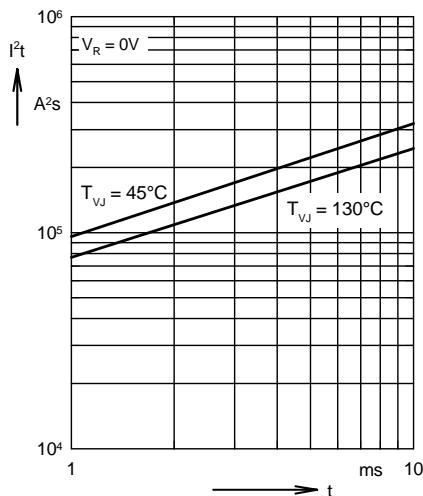


Fig. 4  $I^2t$  versus time (1-10 ms)

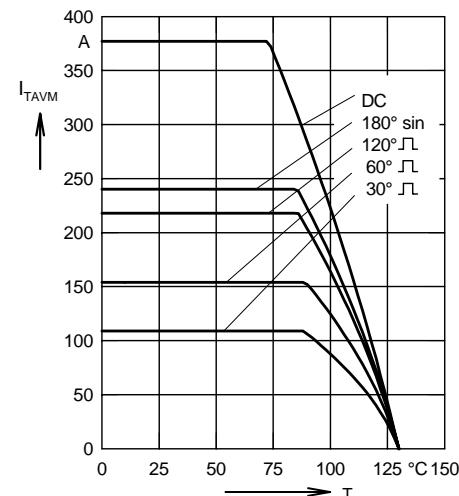


Fig. 4a Maximum forward current  
at case temperature

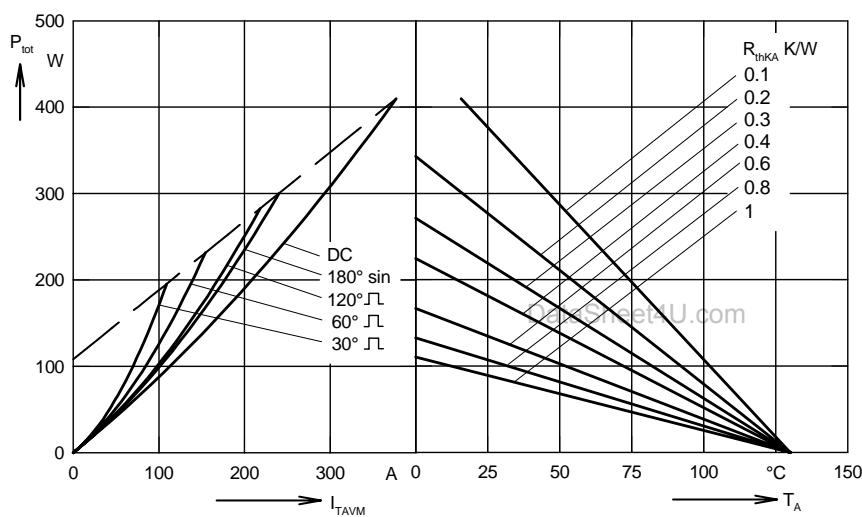


Fig. 5 Power dissipation versus on-state current and ambient temperature (per thyristor or diode)

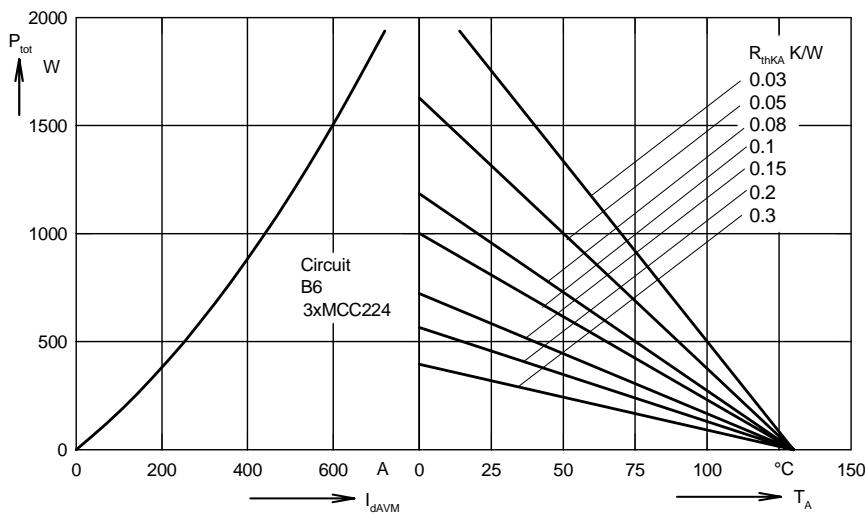


Fig. 6 Three phase rectifier bridge:  
Power dissipation versus direct output current and ambient temperature

